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	Filing Date		2004-02-23	
	First Named Inventor Look		(	
	Art Unit		2613	
	Examiner Name Wai L		i Lun Leung	
	Attorney Docket Numb	er	8433P008	

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	1	Office Action mailed 3 October 2007 for United States Patent Application No. 10/785,618, filed 23 February 2004, 12 pages.								
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			Attorney Docket Number	04337000			
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